TOSHIBA Intelligent Power Device Silicon Monolithic Power MOS Integrated Circuit

## TPD7211F

## Power MOSFET Gate Driver for half-bridge

TPD7211F is a Power MOSFET gate driver for half-bridge circuit. BiCD process is applied on this product.

## Features

- Power MOSFET gate driver for half-bridge
- High-side can operate P channel MOSFET, Low-side can operate N channel MOSFET
- Housed in the PS-8 package and supplied in embossed carrier tape.


Weight: 0.017 g (typ.)

## Pin Assignment (top view)



## Marking



- on the lower left of the marking indicates Pin 1
*Weekly code: (Three digits)


Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain

This product has a MOS structure and is sensitive electrostatic discharge.

Block Diagram / Application Circuit


## Pin Description

| Pin No. | Symbol | Pin Description |
| :---: | :---: | :--- |
| 1 | IN1 | Input pin for high-side output (OUT1) control. The IN1 pin has an internal pull-down resistor. <br> Thus, even if the input is open-circuit, the OUT1 never turns on ("L") inadvertently. |
| 2 | STBY | Standby pin:By driving this pin "L", supply current is 10 $\mu \mathrm{A}$ or less and all outputs can be turned off <br> regardless of input signals. By driving this pin "H", all outputs are switching normally. <br> The STBY pin has an internal pull-down resistor. When input is open circuit, this IC becomes the same <br> operation as "L". |
| 3 | IN2 | Input pin for low-side output (OUT2) control. The IN2 pin has an internal pull-down resistor. <br> Thus, even if the input is open-circuit, the OUT2 never turns on ("H") inadvertently. |
| 4 | GND | Ground pin. |
| 5 | OUT2 | Drives the low-side N channel power MOSFET. |
| 6 | N.C | No-Connect pin. |
| 7 | VDD | Power supply pin. |
| 8 | OUT1 | Drives the high-side P channel power MOSFET. |

Absolute Maximum Ratings ( $\mathrm{Ta}=25^{\circ} \mathrm{C}$ )

| Characteristics | Symbol | Pin | Rating | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Power supply voltage | $V_{D D}$ | $V_{D D}$ | -0.3 to 35 | V | When $\mathrm{V}_{\mathrm{DD}}$ range is 30 V or more, Pulse width $\leq 0.3 \mathrm{~s}$ |
| Input voltage | $\mathrm{V}_{\text {IN }}$ | IN1, IN2 | -0.3 to 6 | V | - |
|  | $V_{\text {StBY }}$ | STBY | -0.3 to 35 | V | When $V_{D D}$ range is 30 V or more, Pulse width $\leq 0.3 \mathrm{~s}$ |
| Output voltage | Vout | OUT1, OUT2 | -0.3 to $\mathrm{V}_{\mathrm{DD}}+0.3$ | V | Absolute Maximum Ratings is 35 V or less. When VDD range is 30 V or more, Pulse width $\leq 0.3 \mathrm{~s}$ |
| Output current | IOUT | OUT1, OUT2 | $\pm 500$ | mA | - |
| Power dissipation(Note 2) | $\mathrm{P}_{\mathrm{D}(1)}$ | - | 0.7 | W | Refer to Note 2a |
|  | $\mathrm{P}_{\mathrm{D}(2)}$ | - | 0.35 | W | Refer to Note 2b |
| Operating temperature | $\mathrm{T}_{\text {opr }}$ | - | -40 to 125 | ${ }^{\circ} \mathrm{C}$ | - |
| Junction temperature | $\mathrm{T}_{\mathrm{j}}$ | - | 150 | ${ }^{\circ} \mathrm{C}$ | - |
| Storage temperature | $\mathrm{T}_{\text {stg }}$ | - | -40 to 150 | ${ }^{\circ} \mathrm{C}$ | - |

Note1: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Thermal Resistance

| Characteristic | Symbol | Rating | Unit |
| :---: | :---: | :---: | :---: |
| Junction to ambient thermal resistance | $\mathrm{R}_{\text {th }}(\mathrm{j}-\mathrm{a})$ | 178.6 (Note 2a) |  |
|  |  | 357.2 (Note 2b) |  |

Note 2:
(a)Mounted on glass epoxy board
(b) Mounted on glass epoxy board



Glass epoxy board
Material : FR-4
$25.4 \mathrm{~mm} \times 25.4 \mathrm{~mm} \times 0.8 \mathrm{~mm}$

Electrical Characteristics
(Unless otherwise specified, $\mathrm{T}_{\mathrm{j}}=-40$ to $125^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5$ to $18 \mathrm{~V}, \mathrm{~V}_{\mathrm{STBY}}=5 \mathrm{~V}$ )

| Characteristics | Symbol | Pin | Condition | Min | Typ. | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating supply voltage | $\mathrm{V}_{\text {DD(opr }}$ | $V_{\text {DD }}$ | - | 5 | 12 | 18 | V |
| Supply current | IDD1 | $V_{D D}$ | $V_{S T B Y}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=12 \mathrm{~V}$, <br> Output pin is open. | - | - | 10 | $\mu \mathrm{A}$ |
|  | IDD2 | $V_{D D}$ | $\mathrm{V}_{\mathrm{STBY}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN} 1,2}=0 \mathrm{~V}$, Output pin is open. | - | - | 3 | mA |
| High level input voltage | $\mathrm{V}_{\mathrm{IH} 1}$ | IN1,IN2 | - | 3.5 | - | - | V |
|  | $\mathrm{V}_{\mathrm{IH} 2}$ | STBY |  | 3.5 | - | - | V |
| Low level input voltage | VIL1 | IN1,IN2 |  | - | - | 1.5 | V |
|  | VIL2 | STBY |  | - | - | 0.8 | V |
| High level input current | $\mathrm{I}_{\mathrm{H} 1}$ | IN1,IN2 | $\mathrm{V}_{\text {IN } 1,2}=5 \mathrm{~V}$, per one input. | - | 20 | 50 | $\mu \mathrm{A}$ |
|  | $\mathrm{l}_{1 \mathrm{H} 2}$ | STBY | $\mathrm{V}_{\mathrm{STBY}}=5 \mathrm{~V}$ | - | 15 | 50 | $\mu \mathrm{A}$ |
| Low level input current | IIL1 | IN1,IN2 | $\mathrm{V}_{\text {IN } 1,2}=0 \mathrm{~V}$, per one input. | -0.2 | - | +0.2 | $\mu \mathrm{A}$ |
|  | IIL2 | STBY | $\mathrm{V}_{\text {STBY }}=0 \mathrm{~V}$ | -0.2 | - | +0.2 | $\mu \mathrm{A}$ |
| High-side(OUT1) high-level output voltage | $\mathrm{V}_{\mathrm{O} 1 \mathrm{H}}$ | OUT1 | $\mathrm{V}_{\mathrm{IN} 1}=0 \mathrm{~V}, \mathrm{I}_{0}=-10 \mathrm{~mA}$ | $\begin{aligned} & \text { VDD } \\ & -0.2 \end{aligned}$ | - | - | V |
| High-side(OUT1) low-level output voltage | $\mathrm{V}_{\text {O1L }}$ | OUT1 | $\mathrm{V}_{\mathrm{IN} 1}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{O}}=+10 \mathrm{~mA}$ | - | - | 0.2 | V |
| Low-side(OUT2) high-level output voltage | $\mathrm{V}_{\mathrm{O} 2 \mathrm{H}}$ | OUT2 | $\mathrm{V}_{\mathrm{IN} 2}=5 \mathrm{~V}, \mathrm{I}_{0}=-10 \mathrm{~mA}$ | $\begin{aligned} & V_{D D} \\ & -0.2 \end{aligned}$ | - | - | V |
| Low-side(OUT2) low-level output voltage | $\mathrm{V}_{\text {O2L }}$ | OUT2 | $\mathrm{V}_{\mathrm{IN} 2}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{O}}=+10 \mathrm{~mA}$ | - | - | 0.2 | V |
| Output ON Resistance | RDS(ON)[SOURCE] | OUT1, OUT2 | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}, \mathrm{I}_{0}=-250 \mathrm{~mA}$ | - | 4 | 8 | $\Omega$ |
|  | $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})[\mathrm{SINK}}$ | OUT1, OUT2 | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}, \mathrm{I}_{0}=+250 \mathrm{~mA}$ | - | 3 | 6 |  |
| Switching times | $\mathrm{t}_{\mathrm{d} \text { (on) } 1}$ | OUT1 | $\begin{aligned} & V_{D D}=12 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{O}}=25 \Omega, \mathrm{C}_{\mathrm{o}}=5000 \mathrm{pF} \end{aligned}$ | - | 0.25 | 1 |  |
|  | toN1 |  |  | - | 0.5 | 2 |  |
|  | $\mathrm{t}_{\mathrm{d} \text { (off) } 1}$ |  |  | - | 0.25 | 1 |  |
|  | toFF1 |  |  | - | 0.5 | 2 |  |
|  | $\mathrm{t}_{\mathrm{d}(\mathrm{on}) 2}$ | OUT2 |  | - | 0.25 | 1 |  |
|  | ton2 |  |  | - | 0.5 | 2 |  |
|  | $t_{d}$ (off)2 |  |  | - | 0.25 | 1 |  |
|  | toFF2 |  |  | - | 0.5 | 2 |  |
| Dead times | $t_{\text {dead1 }}$ | OUT1, OUT2 |  | - | - | 1 | $\mu \mathrm{s}$ |
|  | $\mathrm{t}_{\text {dead2 }}$ | OUT1, <br> OUT2 |  | - | - | 1 |  |

*Please set the deadtime of the input signal after considering the switching time of external power MOSFET.
*The condition of the typical value is $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}$.

Switching times test circuit


Timing chart


## Truth Table

| STBY signal | IN1 signal | IN2 signal | VOUT1 | Vout2 | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
| L | L | L | H | L | Standby mode (Output is all off) |
| L | H | L | H | L |  |
| L | L | H | H | L |  |
| L | H | H | H | L |  |
| H | L | L | H | L | OUT1 and OUT2 are off mode. (External MOSFETs are all off mode) |
| H | H | L | L | L | OUT1 is on mode. (External high side MOSFET is on mode) |
| H | L | H | H | H | OUT2 is on mode. (External low side MOSFET is on mode) |
| H | H | H | H | L | High-side/Low-side arm shorting mode. |





IDD1 $-T_{j}$


IDD2-T

$\mathrm{V}_{\mathrm{IH} 2}, \mathrm{~V}_{\mathrm{IL} 2}-\mathrm{T}_{\mathrm{j}}$








$V_{O 2 L}-V_{D D}$

$\mathrm{V}_{\mathrm{O} 1 \mathrm{~L}}-\mathrm{T}_{\mathrm{j}}$


$V_{O 2 L}-T_{j}$




RDS(ON)[SINK] - IOUT



$\mathrm{R}_{\mathrm{DS}(\mathrm{ON})[\mathrm{SINK}]}-\mathrm{T}_{\mathrm{j}}$






Switching times (OUT2) $-\mathrm{T}_{\mathrm{j}}$


## Package Dimensions

SON8-P-0303-0.65
Unit:mm


Weight: 0.017 g (typ.)

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